



PC Board Layout
Component Side Shown

NOTES:

MATERIAL :

- 1.HOUSING MATERIAL :GLASS FILLED POLYESTER UL94V-0.
- 2.CONTACT MATERIAL :PHOSPHOR BRONZE $\phi 0.46\text{mm}$.
- 3.PLATING :GOLD PLATING OVER NICKEL.

ELECTRICAL:

- 1.VOLTAGE RATING :125 VAC RMS.
- 2.CURRENT RATING :1.5 AMP.
- 3.CONTACT RESISTANCE :30 MILLIOHMS MAX.
- 4.INSULATION RESISTANCE :500 MEGOHMS MIN @ 500V DC .
- 5.DIELECTRIC WITHSTANDING RESISTANCE :1000V AC RMS 50Hz. 1MIN.

MECHANICAL:

- 1.DURRABILITY :750 CYCLES MIN.
- 2.PCB RETENTION PRE-SOLDER :1 LB MIN.

ENVIRONMENTAL:

- 1. STORAGE : -40°C~+85°C
- 2. OPERATION : 0°C TO 70°C.

DETACHED LISTS THIRD ANGLE PROJECTION		DFTO: SHB	DATE: 2007.05.03	<h1 style="margin: 0;">Coorle Technology</h1>		
	TOLERANCES EXCEPT AS NOTED	CHKD: LANBO	DATE: 2007.05.03			
	NM .0 ± 0.15 .00 ± 0.075 .000 ± 0.05	± ± ±	MFD	DATE	<h2 style="margin: 0;">TITLE</h2> <h3 style="margin: 0;">5225 8P8C 1*2 180D</h3>	
	ANGLES = 0.5	±	APPVL	DATE		
MATERIAL :		QT'Y :		DRAWING NO. TESSD1001 /PART NO.		
FINISH :		SCALE :				SIZE A3
DO NOT SCALE DRAWING				SHEET X		